Rev. 5/30/01

Effective March 1998

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

	riginal () Supplemental () Su	ibstitute () PCT	() Design	
As a below named invito my name; that I verily believe that I aminventor (if plural inventors are named below.	entor, I hereby declare that: my re the original, first and sole inven tw) of the subject matter which is	tor (if only one name	is listed below) or an or	ininal first and inine
Title: A METHOD OF MOUNTING A	SEMICONDUCTOR LASER (COMPONENT ON	A SUBMOUNT	
of which is described and claimed in: (X) the attached specification, or () the specification in the application Seria and with amendments through () the specification in International Application in International Internation	ation No., filed, and as amended aderstand the content of the above datent and Trademark Office all in 66. 35, United States Code, '119 (ar and have also identified below an	on_ (if applicable). c-identified specificati formation known to a	ne to be material to pater	stability as defined in
COUNTRY	APPLICATION NO.	I	OATE OF FILING	PRIORITY CLAIMED
Japan	P 2001-354758	No	vember 20, 2001	МО
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hereby claim the benefit under Title 35, I natter of each of the claims of this appl paragraph of Title 35, United States Code Code of Federal Regulations, '1.56 which late of this application.	ication is not disclosed in the pr	ior United States app disclose information r	plication in the manner property as	provided by the first
natter of each of the claims of this apploaragraph of Title 35, United States Code Code of Federal Regulations, '1.56 which	ication is not disclosed in the pr	ior United States application to the prior application to the prior application	plication in the manner property as	provided by the first defined in Title 37, T international filing ED, PENDING,
natter of each of the claims of this apploaragraph of Title 35, United States Code Code of Federal Regulations, '1.56 which late of this application.	cation is not disclosed in the pr '112, I acknowledge the duty to a occurred between the filing date a	ior United States application to the prior application to the prior application	olication in the manner praterial to patentability as and the national or PC STATUS: PATENT	provided by the first defined in Title 37, T international filing ED, PENDING,

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from <u>AOYAMA & PARNTERS</u>, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

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I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon. november 20, 7003

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The above	application may be m	ore particularly ident	ified as follows:			
U.S. Applic	ation Serial No.		Filing Date		_	
Applicant R	Reference Number 5	38060	Atty Docket No.			

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Title of Invention A METHOD OF MOUNTING A SEMICONDUCTOR LASER COMPONENT ON A SUBMOUNT